

Amkor Package Capability

Package Type & Body Size	Leadcount and Technology	Factory
MMC (MMC plus), RS-MMC (MMC mobile)		
24x32x1.4 mm	7/13 Lidded/Laminate	C1
24x18x1.4 mm	7/13 Lidded/Laminate (RS-MMC)	C1
SD (Secure Digital)		
24x32x2.1 mm	9 Lidded/Laminate	C1
MMCmicro		
12x14x1.1 mm	10 Lidded/Laminate (MMCplus)	C1
miniSD		
20x21.5x1.4 mm	11 Lidded/Laminate	C1
microSD		
11x15x1.0 mm	8 Fully molded	C1
MS micro		
12.5x15x1.2 mm	11 Lidded/Laminate	C1
SIM Card		
15x25x0.76 mm	8 Fully molded	C1

C1 = Shanghai, China

